

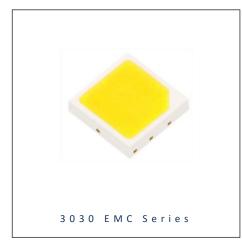


# **PRODUCT DATASHEET**



- EMC 2-PIN SMD
  3030 0.66t
- Natural White (4000K)





N0W61S95

## **APPLICATIONS:**

- General Lighting
- Portable Lighting
- Commercial Lighting
- Indoor Lighting
- Backlight for LCD

# 3030 EMC Series



## **FEATURES:**

- Package: Top View EMC White Package
- Forward Current: 120mA
- Forward Voltage (typ.): 6.0V
- Luminous Flux (typ.): 122lm@120mA
- Colour: Natural White
- Colour Temperature (CCT): 4000K
- Viewing angle: 120°
  - Materials:
    - Die: InGaN
    - Resin: Silicon (Yellow Diffused)
    - Package: EMC
- Operating Temperature: -40~+105°C
- Storage Temperature: -40~+105°C
- Grouping parameters:
  - Forward Voltage
  - Luminous Flux
  - CIE Chromaticity
- Soldering methods: Reflow Soldering
- MSL Level: MSL3 according to J-STD020
- Packing: 8mm tape with max.5000/reel, ø178mm (7")





# CHARACTERISTICS:

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lF	240	mA
Pulse Forward Current (Duty 1/10, width≤100µS)	Ipf	300	mA
Power Dissipation	PD	1536	mW
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @10V	IR	10	μΑ
Junction Temperature	Tj	120	°C
Thermal Resistance (Junction to Solder Point)	R <sub>THJS</sub>	12	°C/W
Operating Temperature	Topr	-40~+105	°C
Storage Temperature	Т <sub>stg</sub>	-40~+105	°C
Soldering Temperature	Tsol	230/260 for 10S	°C
Colour Rendering Index	CRI	80	

## Electrical & Optical Characteristics (Ta=25°C, RH=60%)

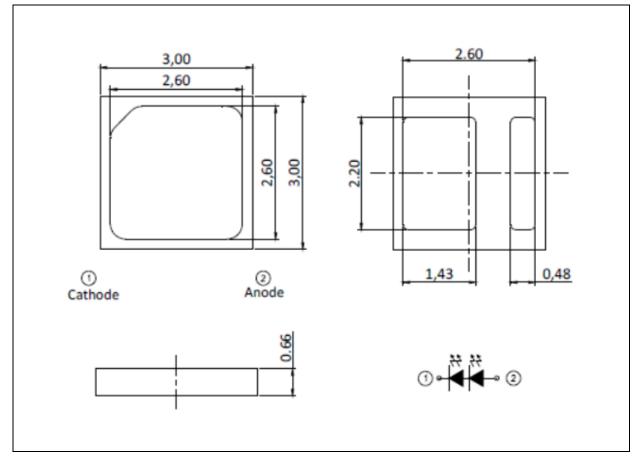
Doromotor	Sumbol		Values	l loit	Test		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	VF	5.8	6.0	6.6	V	I <sub>F</sub> =120mA	
Luminous Flux	Φv	115	122		lm	I⊧=120mA	
Luminous Efficiency			169		lm/W	I⊧=120mA	
Chromaticity	х		0.3865			1. 120 m 4	
Coordinates	Y		0.3881			I <sub>F</sub> =120mA	
Colour Temperature	ССТ		4000		К	I <sub>F</sub> =120mA	
Viewing Angle	2 <b>θ</b> 1/2		120		deg	I⊧=120mA	

1. Luminous flux ( $\Phi_V$ ) ±10%, Forward Voltage (V<sub>F</sub>) ±0.1V, CRI ±2



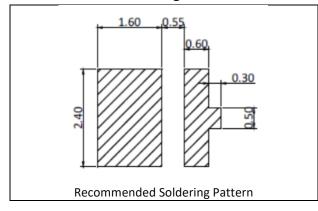


## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

#### **Recommended Soldering Pad Dimension:**



1. Dimensions are in millimetre (mm).

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2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



## **BINNING GROUPS:**

Code	Min.	Max.	Unit
A4	5.8	6.0	
B4	6.0	6.2	N/
C4	6.2	6.3	V
D4	6.3	6.6	

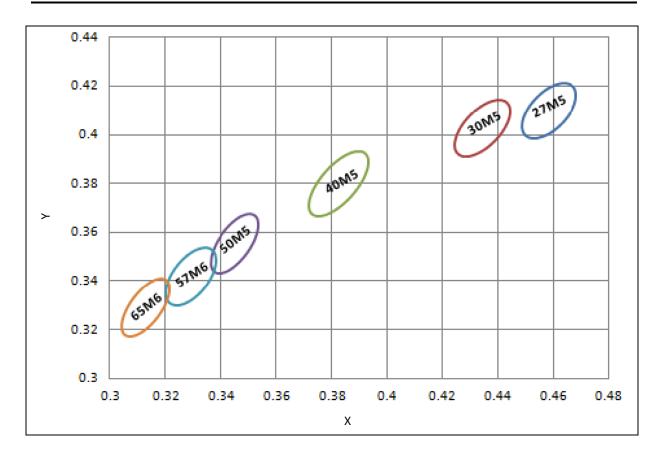
## Forward Voltage Classifications (I<sub>F</sub> = 120mA):

## Luminous Flux Classifications (I<sub>F</sub> = 120mA):

Code	Min.	Max.	Unit
5H	115	120	
5J	120	125	
5K	125	130	lm
5L	130	135	
5M	135	140	



## **CIE CHROMATICITY DIAGRAM:**



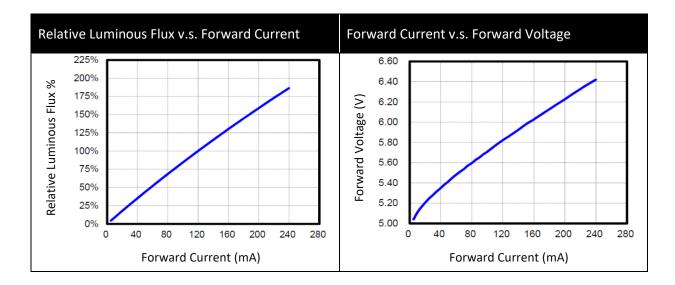
### Chromaticity Coordinates Classifications (I<sub>F</sub> = 120mA):

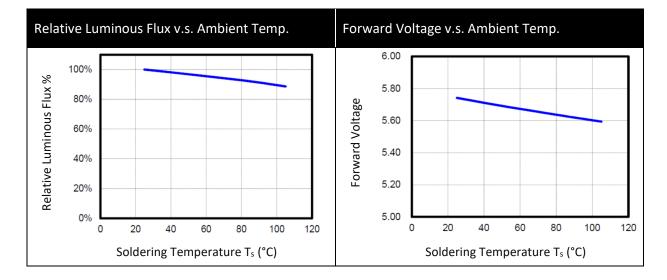
Ra80: *B	Code	Centre		Radius		Angle
3 *вј *вк		Х	Y	а	b	Φ
*BD *BF 6 2 *BD *BD 6 *BD 7 1 8	5B-3STEP	0.2865	0 2001	0.009390	0.004020	52.42
	5B-5STEP	0.3865	0.3881	0.015650	0.006700	53.43

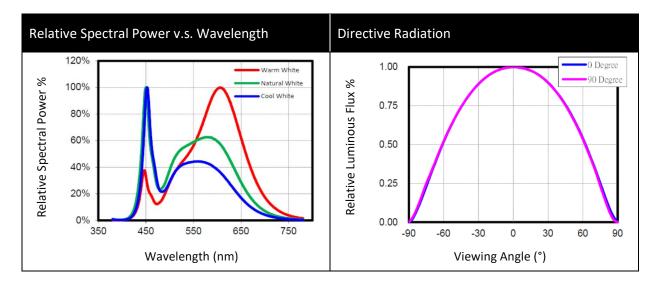
	1		1 2		3		4	
	Х	Y	Х	Y	Х	Y	Х	Y
1	0.3707	0.3656	0.3773	0.3952	0.4043	0.4122	0.3935	0.3794



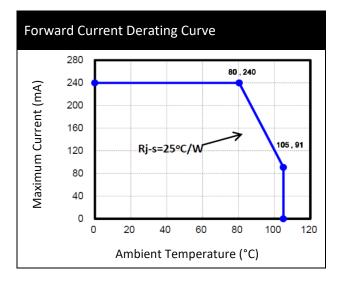
## **ELECTRO-OPTICAL CHARACTERISTICS:**





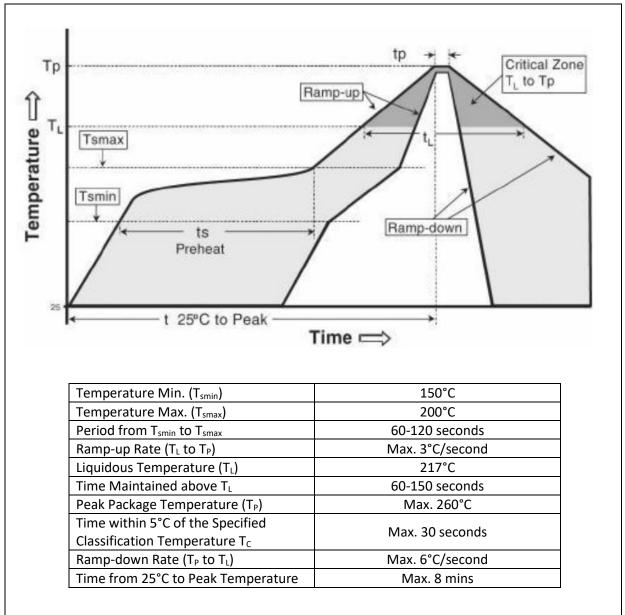








## **RECOMMENDED SOLDERING PROFILE:**



Reflow Lead-free Solder:

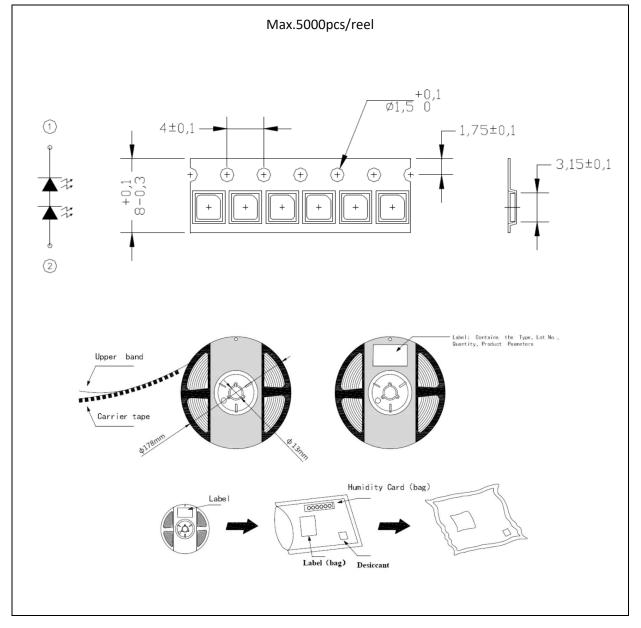
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



## PACKING SPECIFICATION:

### Reel Dimension:



## **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

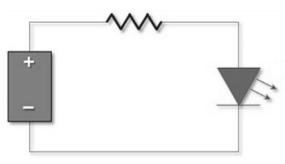
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	13/07/2022	Datasheet set-up.